

V _{CES}	650V
I _{C(100°C)}	5A
V _{CE(sat) (Typ.)}	1.65V@I _c =8A
P _D	22W

Features

- 1) Low Collector Emitter Saturation Voltage
- 2) Low Switching Loss
- 3) Short Circuit Withstand Time 5µs
- 4) Built in Very Fast & Soft Recovery FRD (RFN - Series)
- 5) Pb free Lead Plating ; RoHS Compliant

Applications

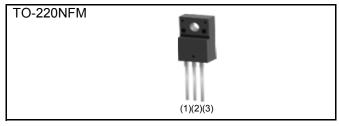
General Inverter

UPS

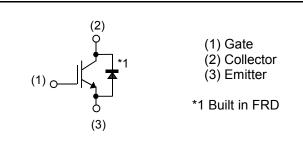
Power Conditioner

Welder

Outline



Inner Circuit



Packaging Specifications

Туре	Packaging	Tube
	Reel Size (mm)	-
	Tape Width (mm)	-
	Basic Ordering Unit (pcs)	1,000
	Packing Code	C9
	Marking	RGT16TM65D

•Absolute Maximum Ratings (at T_C = 25°C unless otherwise specified)

		7		
Parameter		Symbol	Value	Unit
Collector - Emitter Voltage		V _{CES}	650	V
Gate - Emitter Voltage		V _{GES}	±30	V
Collector Current	T _C = 25°C	Ι _C	9	А
	T _C = 100°C	Ι _C	5	А
Pulsed Collector Current		I _{CP} *1	24	А
Diode Forward Current	T _C = 25°C	١ _F	13	А
Diode Forward Current	T _C = 100°C	١ _F	7	А
Diode Pulsed Forward Current		I _{FP} ^{*1}	24	А
Power Dissipation	T _C = 25°C	P _D	22	W
Power Dissipation	T _C = 100°C	P _D	11	W
Operating Junction Temperature		Tj	-40 to +175	°C
Storage Temperature		T _{stg}	-55 to +175	°C
*1 Pulse width limited by T		•	•	

*1 Pulse width limited by T_{jmax.}

Thermal Resistance

Parameter	Symbol	Values			Unit
Faranielei	Symbol	Min.	Тур.	Max.	Offic
Thermal Resistance IGBT Junction - Case	$R_{\theta(j\text{-}c)}$	-	-	6.53	°C/W
Thermal Resistance Diode Junction - Case	$R_{\theta(j\text{-}c)}$	-	-	6.70	°C/W

●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit	
Parameter Symbol		Conditions	Min.	Тур.	Max.	Offic	
Collector - Emitter Breakdown Voltage	BV _{CES}	I _C = 10μΑ, V _{GE} = 0V	650	-	-	V	
Collector Cut - off Current	I _{CES}	V _{CE} = 650V, V _{GE} = 0V	-	-	10	μA	
Gate - Emitter Leakage Current	I _{GES}	V _{GE} = ±30V, V _{CE} = 0V	-	-	±200	nA	
Gate - Emitter Threshold Voltage	V _{GE(th)}	V _{CE} = 5V, I _C = 5.5mA	5.0	6.0	7.0	V	
Collector - Emitter Saturation Voltage	V _{CE(sat)}	I _C = 8A, V _{GE} = 15V T _j = 25°C T _j = 175°C	-	1.65 2.15	2.1	V	

•IGBT Electrical Characteristics (at $T_j = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Conditions	Values			
			Min.	Тур.	Max.	Unit
Input Capacitance	C _{ies}	V _{CE} = 30V	-	450	-	
Output Capacitance	C _{oes}	V _{GE} = 0V	-	21	-	pF
Reverse Transfer Capacitance	C _{res}	f = 1MHz	-	8	-	
Total Gate Charge	Q_g	V _{CE} = 300V	-	21	-	
Gate - Emitter Charge	Q_{ge}	I _C = 8A	-	6	-	nC
Gate - Collector Charge	Q_{gc}	V _{GE} = 15V	-	8	-	
Turn - on Delay Time	t _{d(on)}	I _C = 8A, V _{CC} = 400V	-	13	-	
Rise Time	t _r	V _{GE} = 15V, R _G = 10Ω	-	13	-	ns
Turn - off Delay Time	t _{d(off)}	T _j = 25°C	-	33	-	
Fall Time	t _f	Inductive Load	-	95	-	
Turn - on Delay Time	t _{d(on)}	I _C = 8A, V _{CC} = 400V	-	13	-	
Rise Time	t _r	V _{GE} = 15V, R _G = 10Ω	-	14	-	
Turn - off Delay Time	$t_{d(off)}$	T _j = 175°C	-	50	-	ns
Fall Time	t _f	Inductive Load	-	120	-	
		I _C = 24A, V _{CC} = 520V				
Reverse Bias Safe Operating Area RBSOA		V _P = 650V, V _{GE} = 15V	FULL SQUARE			-
		R _G = 50Ω, T _j = 175°C				
		$V_{CC} \leq 360V$				
Short Circuit Withstand Time	t _{sc}	V _{GE} = 15V	5	-	-	μs
		T _j = 25°C				

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•FRD Electrical Characteristics (at $T_j = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Тур.	Max.	Unit
Diode Forward Voltage	V _F	I _F = 8A T _j = 25°C T _j = 175°C	-	1.4 1.2	1.9	V
Diode Reverse Recovery Time	t _{rr}	$I_F = 8A$ $V_{CC} = 400V$ $di_F/dt = 200A/\mu s$ $T_j = 25^{\circ}C$	-	42	-	ns
Diode Peak Reverse Recovery Current	I _{rr}		-	5.2	-	А
Diode Reverse Recovery Charge	Q _{rr}		-	0.12	-	μC
Diode Reverse Recovery Time	t _{rr}	I _F = 8A V _{CC} = 400V di _F /dt = 200A/µs T _j = 175°C	-	116	-	ns
Diode Peak Reverse Recovery Current	I _{rr}		-	8.1	-	А
Diode Reverse Recovery Charge	Q _{rr}		-	0.51	-	μC

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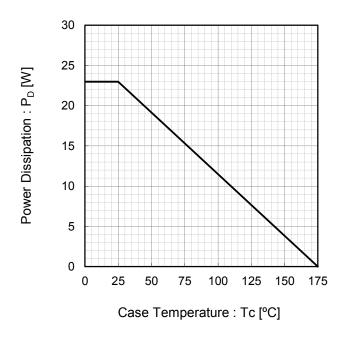


Fig.1 Power Dissipation vs. Case Temperature

Fig.2 Collector Current vs. Case Temperature

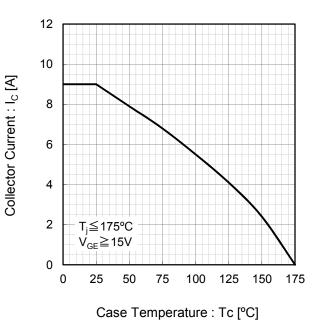
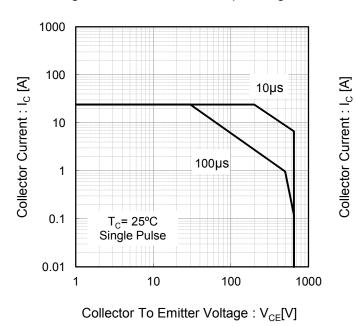
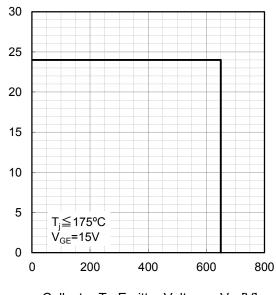


Fig.3 Forward Bias Safe Operating Area

Fig.4 Reverse Bias Safe Operating Area





Collector To Emitter Voltage : $V_{\text{CE}}[V]$

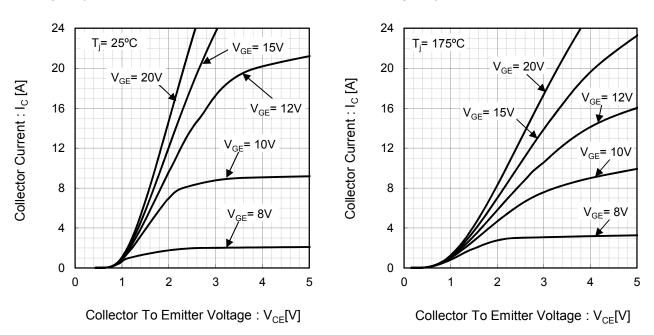


Fig.5 Typical Output Characteristics

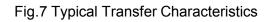
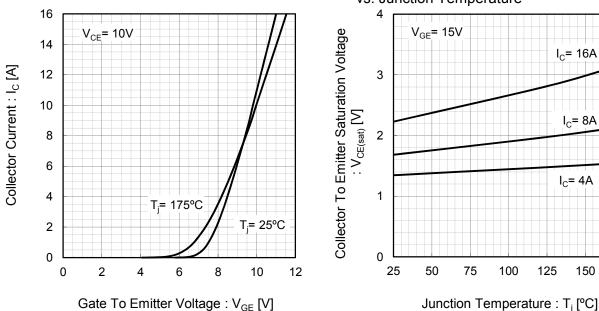


Fig.8 Typical Collector To Emitter Saturation Voltage vs. Junction Temperature

Fig.6 Typical Output Characteristics



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I_c= 16A

I_C= 8A

 $I_{C} = 4A$

150

175

T_i= 175°C

 $I_{\rm C}$ = 4A

I_C= 8A

I_C= 16A

15

20

50

Fig.10 Typical Collector To Emitter Saturation Voltage

Electrical Characteristic Curves

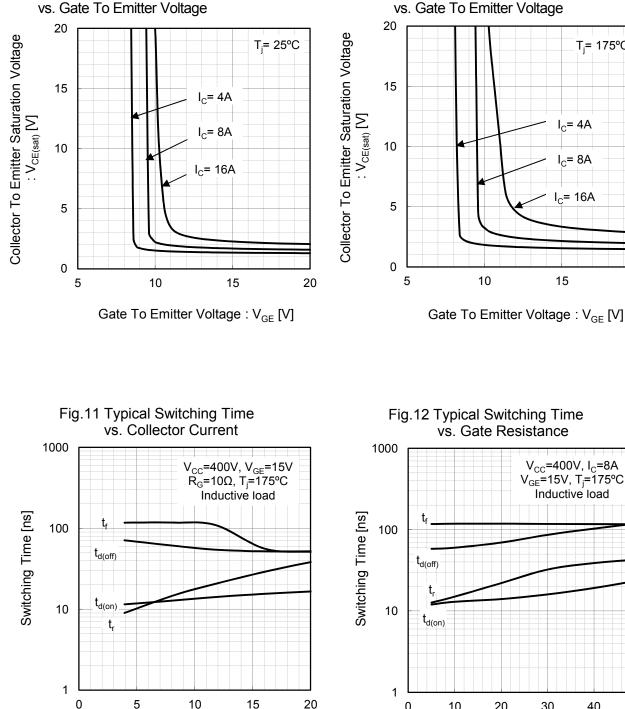


Fig.9 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage

Collector Current : I_C [A]

0

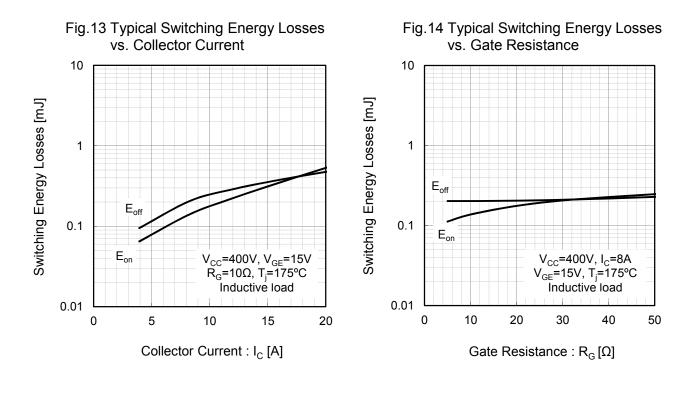
10

20

30

Gate Resistance : $R_G[\Omega]$

40



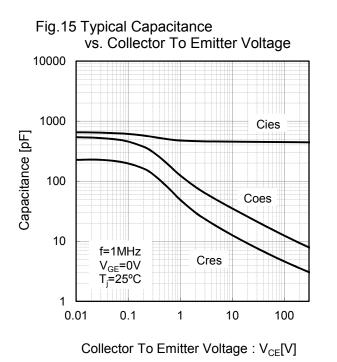
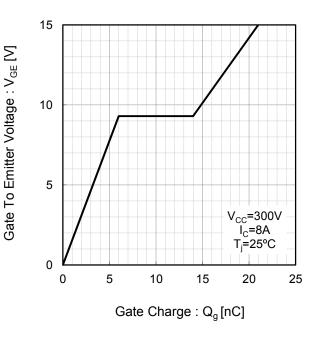


Fig.16 Typical Gate Charge



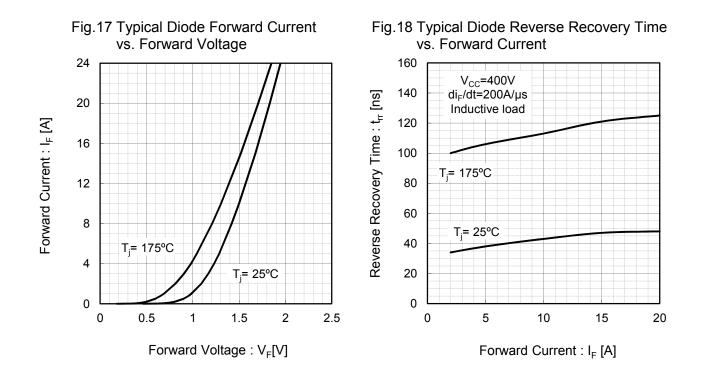


Fig.19 Typical Diode Reverse Recovery Current vs. Forward Current

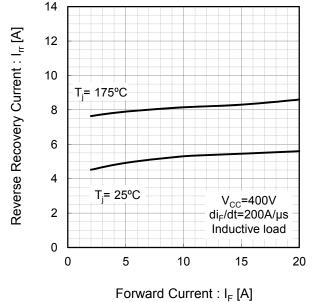
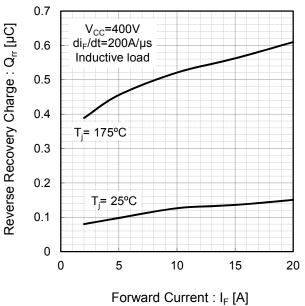


Fig.20 Typical Diode Reverse Recovery Charge vs. Forward Current



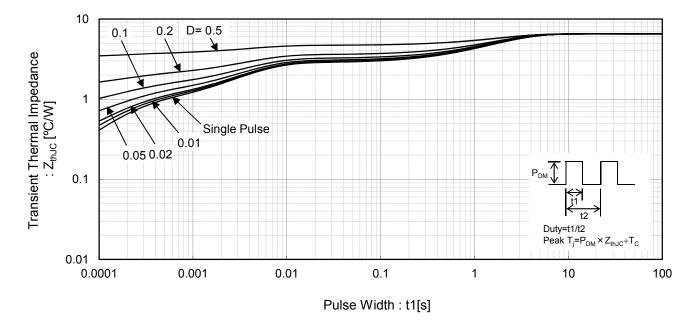
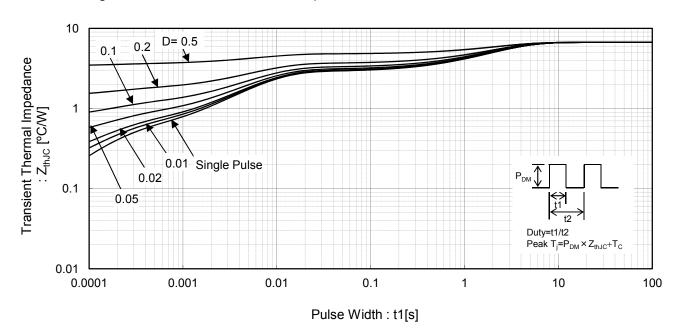


Fig.21 IGBT Transient Thermal Impedance





●Inductive Load Switching Circuit and Waveform

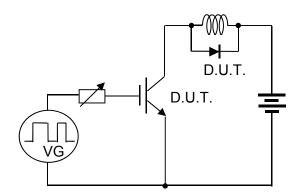


Fig.23 Inductive Load Circuit

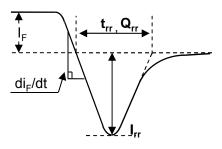


Fig.25 Diode Reverce Recovery Waveform

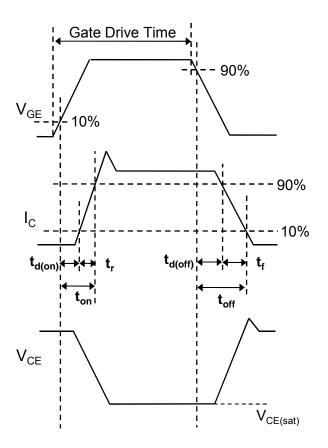


Fig.24 Inductive Load Waveform

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